



Physical Interface & Carriers Japan TC Chapter

Japan Standards Winter 2021 Meetings
December 17
SEMI Japan office, Tokyo, Japan/WEB
13:00-17:00 (JST)

SVM Software (for voting) ※SVM へのログインもお願いします。

1. Open a Web browser and go to: <https://svm.semi.org/> (Do not use Internet Explorer or MS Edge)
2. Click "Login"
3. Enter your Standards Membership username and password (same login for voting on ballots).
1. If you have forgotten your username and/or password, they may be retrieved at: <https://ams.semi.org/ebusiness/ForgotUID.aspx>
2. Find the meeting room: < PIC Japan TC Chapter, Dec 17, 2021 >
3. Click "Go"

AGENDA (Tentative)

1.0 Welcome / Call to Order

- 1.1 Introductions
- 1.2 Meeting Reminders (*Membership Requirement, Antitrust and Intellectual Property Reminders, Effective Meeting Guidelines*)
- 1.3 Agenda Review

2.0 Review of Previous Meeting Minutes

3.0 Technical Committee Awards

4.0 Liaison Report

- 4.1 North America

5.0 Staff Report

6.0 Ballot Review

- 6.1 None

7.0 Subcommittee & Task Force Reports

- 7.1 300 mm Tape Frame PI&C TF
- 7.2 Global PIC Standards Maintenance TF
- 7.3 Japan Electron Microscopy Workflow liaison TF
- 7.4 Panel Level Packaging Panel FOUP TF
- 7.5 [Liaison: 3D Packaging & Integration JA TC Chapter] Panel Level Packaging Glass Carrier TF
- 7.6 [Liaison: 3D Packaging & Integration NA TC Chapter] Panel Level Packaging Panel TF

8.0 Old Business

- 8.1 Project Period Review
- 8.2 5-Year Review
 - 8.2.1 SEMI E83-0515: Specification for PGV Mechanical Docking Flange
 - 8.2.2 SEMI E156-1115: Specification for Mechanical Interfaces Between 450 mm Automated Material Handling Systems (AMHS) Stocker to Transport Equipment
 - 8.2.3 SEMI E92-0302E (Reapproved 0615): Specification for 300 mm Light Weight and Compact Box Opener/Loader to Tool-Interoperability Standard (Bolts/Light)

9.0 New Business

- 9.1 Proposal of New Activity
 - 9.1.1 SNARF Proposal for Revision of SEMI E181-0321 - Specification for Panel FOUP for Panel Level Packaging

- 9.1.2 SNARF Proposal for Revision of SEMI E181.1-0321 — Specification for Panel FOUN for 510 to 515 mm Panel Size and 12 Slots
- 9.1.3 SNARF Proposal for Revision of SEMI E181.2-0321 — Specification for Panel FOUN for 510 to 515 mm Panel Size and 6 Slots
- 9.1.4 SNARF Proposal for Revision of SEMI E181.3-0321 — Specification for Panel FOUN for 600 to 600 mm Panel Size and 12 Slots
- 9.1.5 SNARF Proposal for Revision of SEMI E181.4-0321 — Specification for Panel FOUN for 600 to 600 mm Panel Size and 6 Slots
- 9.1.6 SNARF Proposal for Line Item Revision of SEMI SEMI E185-1221 — SPECIFICATION FOR 300 mm TAPE FRAME FOUN

10.0 Action Item Review

- 10.1 Open Action Items
- 10.2 New Action Items

11.0 Next Meeting and Adjournment